Amendments to Claims:

- 4. (currently amended) A method of manufacturing a device having an elevated holding voltage, and formed in a semiconductor material of a first conductivity type, the semiconductor material having a dopant concentration, the device comprising
 - a well of a second conductivity type formed in the semiconductor material, the well having a dopant concentration;
 - a first region of the second conductivity type formed in the well, the first region having a dopant concentration greater than the dopant concentration of the well, the first region being connected to a first node;
 - a second region of the first conductivity type formed in the well, the second region having a dopant concentration greater than the dopant concentration of the semiconductor material, the second region being connected to the first node;
 - a third region of the second conductivity type formed in the semiconductor material, the third region having a dopant concentration greater than the dopant concentration of the well, the third region being connected to a second node, and
 - a fourth region of the first conductivity type formed in the semiconductor material, the fourth region having a dopant concentration greater than the dopant concentration of the semiconductor material, and being connected to the second node, the method comprising
 - adjusting the size of the second region to limit injection of minority carriers to achieve the desired elevated holding voltage.
- 5. (previously presented) The method of claim 4, wherein the first conductivity type is p type and the second conductivity type is n type.
- 6. (original) The method of claim 5, wherein, in addition to adjusting the size of the second region, adjusting the size of the third region to increase electron injection to a point where space charge neutralization is sufficiently limited to achieve the desired elevated holding voltage.